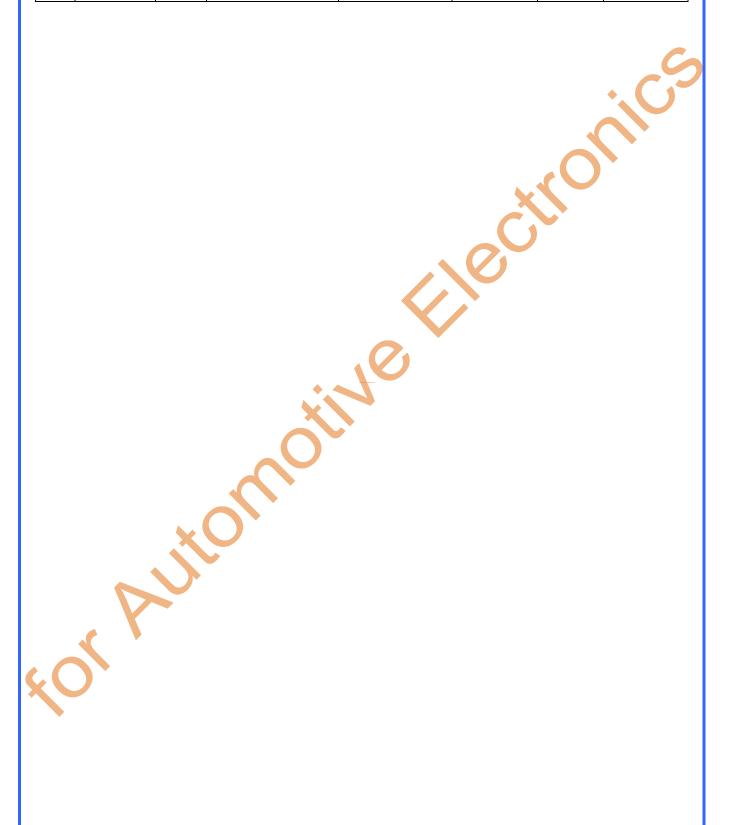
for Automotive Electronics

SPECIFICATIONS

Customer				· ·	
Product Name		Automotive Mo	olded SMD Po	ower Inductor	
Sunlord Part Nur	nber	AM	P0402H Serie	es	
Customer Part N	umber			~(0	
Weight/MPQ		0.18g/pc	s Typ., 300 <mark>0</mark> p	ocs/reel	
[⊠New Released,	,		SPEC	No.: AMP072300	000
[This SPEC is total 1-					
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Shenzhen	Sunlo	rd Electr	onics C	o., Ltd.	
				·	=
Shenzhen Address: Sunlord Indust Tel: +86-755-29832333 Fa	rial Park, Dafuy	ruan Industrial Zone		·	= 518110
Address: Sunlord Indust	rial Park, Dafuy x: +86-755-82269	ruan Industrial Zone	e, Guanlan, She	·	= 518110
Address: Sunlord Industrel: +86-755-29832333 Fa	rial Park, Dafuy x: +86-755-82269	ruan Industrial Zono 029 E-Mail: sunloro	e, Guanlan, She	·	= 518110
Address: Sunlord Industriel: +86-755-29832333 Fa	rial Park, Dafuy x: +86-755-82269 Only Date:	vuan Industrial Zono 029 E-Mail: sunloro	e, Guanlan, She	·	518110
Address: Sunlord Industriel: +86-755-29832333 Fa (For Customer approval Customer a	rial Park, Dafuy x: +86-755-82269 Only] Date:	vuan Industrial Zono 029 E-Mail: sunloro	e, Guanlan, She l@sunlordinc.com	nzhen, China 5	518110
Address: Sunlord Industriel: +86-755-29832333 Fa (For Customer approval Customer a	rial Park, Dafuy x: +86-755-82269 Only] Date:	vuan Industrial Zono 029 E-Mail: sunloro	e, Guanlan, She l@sunlordinc.com	nzhen, China 5	518110
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Address: Sunlord Industrel: +86-755-29832333 Factor	rial Park, Dafuy x: +86-755-82269 Only] Date:	vuan Industrial Zono 029 E-Mail: sunloro	e, Guanlan, She l@sunlordinc.com	nzhen, China 5	518110
Address: Sunlord Industriel: +86-755-29832333 Fa (For Customer approval Customer a	rial Park, Dafuy x: +86-755-82269 Only] Date:	vuan Industrial Zono 029 E-Mail: sunloro	e, Guanlan, She l@sunlordinc.com	nzhen, China 5	518110

	Version Change History							
Rev.	Date	Item	Changed Contents	Change Reasons	Drawing	Check	Approval	
01	1	1	New release	1	1	1	Yubo Su	



	(Content)	
No.	Item	Page
1	Scope	4
2	Product Description and Identification (Part Number)	4
3	Shape and Dimensions	4
4	Electrical Characteristics	5~6
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1 Scope

1.1 Scope of parts

This specification applies to the AMP0402H Series of Automotive Molded SMD power inductor based on AEC-Q200.

1.2 Scope of application

Product numbers recorded in this specification are used for automotive applications.

1.3 Operating and storage temperature

The part temperature (ambient + temp. rise) should not exceed 150 °C under worst case operating conditions. Circuit design, component placement, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

- 1) Operating and storage temperature range (individual chip without packing): -55°C ~ +150°C (including self-heating).
- 2) Storage temperature range (packaging conditions): -10 °C ~+40 °C and RH 70% (Max.).
- 1.4 MSL: level1.

2 Product Description and Identification (Part Number)

1) Description:

AMP0402H series of Automotive Molded SMD power inductor.

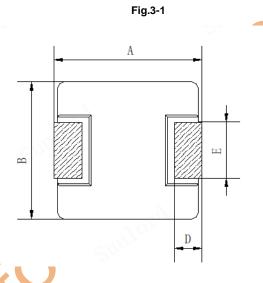
2) Product Identification (Part Number)

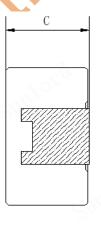
AMP	0402	Н	3R3	М	Т	
1	2	3	4	(5)	6	7

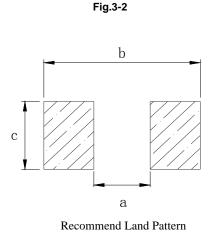
1	Product Type	AMP: Automotive Molded SMD Power Inductor
2	External Dimensions(L×W×H) [mm]	0402: 4.4×4.2×1.8 mm
3	Feature type	H: H type material
4	Nominal Inductance	3R3: 3.3µH, 4R7: 4.7µH, 6R8: 6.8µH, 100: 10.0µH
(5)	Inductance Tolerance	M: ±20%
6	Packing	T: tape & Reel
7	Special Process code	Standard product is blank

3 Shape and Dimensions

Dimensions and recommended PCB pattern for reflow soldering, please see Fig.3-1, Fig. 3-2and Table 3-1.







[Table 3-1] (Unit: mm)

Series	А	В	С	D	E	а	b	С
AMP0402H	4.4±0.4	4.2±0.2	1.8±0.2	0.8±0.2	2.0±0.3	2.2ref.	5.2ref.	2.3ref.

Automotive Molded SMD Power Inductor Business Categories: Level 0 (general confidential)

Electrical Characteristics

Part Number	Inductance	DC Res	sistance	Saturation	on Current	Heat Rating Current	Withstanding Voltage	
	100KHz/1V	Max.	Тур.	Max	Тур.	Тур.	Тур.	Marking
Units	μH	m	Ω		A	Α	V_{DC}	
Symbol	L	DO	CR	Į:	sat	Irms	1	
AMP0402HR10MT	0.10±20%	4.0	3.3	22.0	27	15		R10
AMP0402HR22MT	0.22±20%	7.0	6.0	17.0	22	12		R22
AMP0402HR33MT	0.33±20%	11	8.0	9.0	12	10		R33
AMP0402HR47MT	0.47±20%	14	9.4	8.0	10	9.0		R47
AMP0402HR56MT	0.56±20%	16	12	7.5	9.4	7.8	•	R56
AMP0402HR68MT	0.68±20%	18	12.6	7.4	9.2	7.8		R68
AMP0402H1R0MT	1.0±20%	27	22	6.0	7.5	6.0		1R0
AMP0402H1R2MT	1.2±20%	28	24	5.8	7.3	5.8	60	1R2
AMP0402H1R5MT	1.5±20%	46	31	5.7	7.1	5.2		1R5
AMP0402H2R2MT	2.2±20%	58	48	5.6	7.0	4.2		2R2
AMP0402H3R3MT	3.3±20%	87	70	3.4	4.2	3.4	•	3R3
AMP0402H4R7MT	4.7±20%	105	90	2.4	3.0	3.2		4R7
AMP0402H5R6MT	5.6±20%	170	134	2.3	2.8	2.5		5R6
AMP0402H6R8MT	6.8±20%	175	137	2.0	2.5	2.4		6R8
AMP0402H100MT	10±20%	282	235	1.8	2.3	1.8		100

Note: %1: Rated current: Isat (Max.) or Irms(Typ.), whichever is smaller;

**2 : Saturation Current: Typ. Value, DC current at which the inductance drops approximately 30% from its value without current;

3: Heat Rating Current: DC current that causes an approximate ΔT of 40°C from 20°C ambient.

0.2

0.0

4.00 6.00

DC.Current(A)

8.00

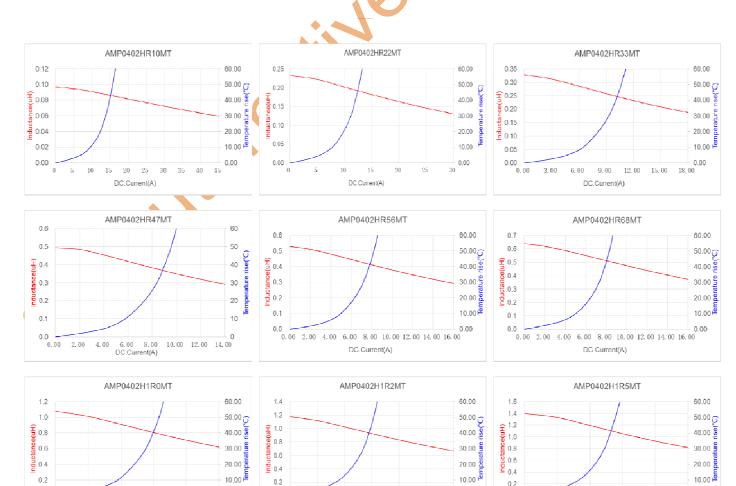
0.00

4.00

6.00

DC.Current(A)

8.00



0.2

0.00

0.00

2.00

4.00

DC.Gurrent(A)

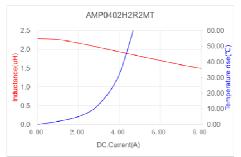
6.00

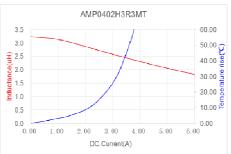
0.00

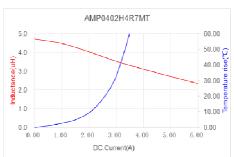
10.00

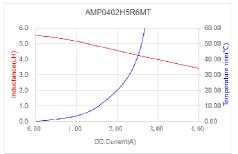
8.00

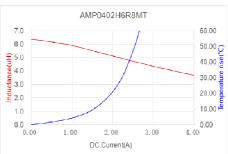
Automotive Molded SMD Power Inductor Business Categories: Level 0 (general confidential)

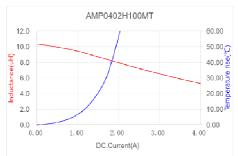












5 Test and Measurement Procedures

5.1 Test Conditions

- 5.1.1 Unless otherwise specified, the standard atmospheric conditions for measurement/test as:
 - a. Ambient Temperature: 20±15℃.
 - b. Relative Humidity: 65±20%.
 - c. Air Pressure: 86kPa to 106kPa.
- 5.1.2 If any doubt on the results, measurements/tests should be made within the following limits:
 - a. Ambient Temperature: 20±2°C.
 - b. Relative Humidity: 65±5%.
 - c. Air Pressure: 86kPa to 106kPa.

5.2 Visual Examination

Inspection Equipment: visual.

5.3 Electrical Test

- 5.3.1 Inductance (L)
 - a. Refer to Item 4.Test equipment: WK3260B LCR meter or equivalent.
 - b. Test Frequency and Voltage: refers to Item 4.
- 5.3.2 Direct Current Resistance (DCR)
 - a. Refer to Item 4.
 - b. Test equipment: HIOKI 3540 or equivalent.
- 5.3.3 Saturation Current (Isat)
 - Refer to Item 4.
 - b. Test equipment: WK3260B LCR meter or equivalent.
- 5.3.4 Temperature rise current (Irms)
 - Refer to Item 4.
 - b. Test equipment (see Fig. 5.3.4-1, Fig.5.3.4-2): Electric Power, Electric current meter, Thermometer.
 - c. Measurement method:
 - 1. Set test current to be 0 mA.
 - 2. Measure initial temperature of choke surface.
 - 3. Gradually increase current and measure choke temperature for corresponding current.
 - 4. Definition of Temperature rise current: DC current that causes the temperature rise (ΔT) from ambient temperature.

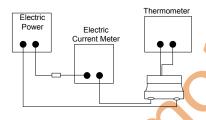


Fig. 5.3.4-1

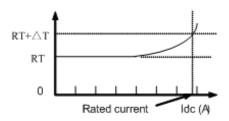


Fig. 5.3.4-2

6 Structure and material list

The structure and material list of AMP0402H products please refer to Fig.6-1 and Table 6-1.

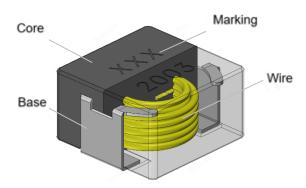


Fig.6-1

[Table. 6-1]

Components	Material
Marking	1
Core	Alloy Sponge Powder
Wire	Polyurethane copper wire
Base	Copper plated with Sn

7 Product Marking

The product marking, please refer to ${\bf Fig.7-1.}$

2R2: Inductance, refer to specifications

2003: trace code



Fig.7-1

8 Reliability Test

8 R	eliability Test		
No.	Test Items	Test Methods	Requirements
1	Visual	Inspect the appearance at least 10X.	No visible mechanical damage
2	Physical Dimension	length, width, thickness of the components.	meet the specifications
3	Pre-and Post -Stress Electrical Test	Inductance of the components DC resistance of the components	(1)The electrical values before the test meet the specifications (2)The electrical values after the test meet the rate of change requirements; Inductance change:Within ±20%
4	Terminal strength	①Precondition: 3 reflow cycles;②Test condition:17.7N,X,Ydirect,60(+5)s,Speed:1.0mm/s.	No removal or split of the termination or other defects shall occur
5	Board Flex	①Precondition: 3 reflow cycles; ②Test condition: 2mm,60(+5)s.	No visible mechanical damage
6	Solderability	Method 1: ①pretreatment:155°C,4h; ②245°C,5(-0.5,+0)s,25 ± 6 mm/s; ③Solder:Sn/3.0Ag/0.5Cu. Method 2: ①Steam aging:8h ±15min; ②245°C,5(-0.5,+0)s,25 ± 6 mm/s; ③Solder:Sn/3.0Ag/0.5Cu.	- Wetting shall be exceeded 95% coverage
e. (317	Method 3: ①Steam aging:8h ±15min; ②260°C,30±5s,25 ± 6 mm/s; ③Solder:Sn/3.0Ag/0.5Cu.	No more than 5% of the solderable termination exhibits exposed underlying, nonwettable base metal or metallization layers or portions of the ceramic substrate after exposure to molten solder
7	Resistance to Soldering Heat	Method 1: Max 260°C/10s, 3 times.Solder:Sn/3.0Ag/0.5Cu. Note: Reflow Profile refer to reflow profile 1	(1)No visible mechanical damage (2) Inductance change: Within ±20%
8	High Frequency Vibration	Reflow 3 times,10~2000Hz,5g,20min/Cycle,4 hours in each 3 mutually perpendicular directions (total of 12 hours) .	(3) DCR: Satisfy electrical characteristic.

Automotive Molded SMD Power Inductor Business Categories: Level 0 (general confidential)

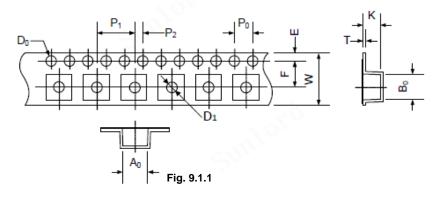
9	Mechanical Shock	Reflow 3 times,Half sine shock pulse,100g,6ms,6 shocks in each 3 mutually perpendicular directions (total of 18 shocks).	
10	Temperature Cycling	Reflow 3 times, ambient temperature -55°C/(30min), ambient temperature+150°C/(30min), transforming interval:20s,1000 cycles.	
11	Low Temperature Exposure (Storage)	①Precondition: 3 reflow cycles; ②Test condition: ambient temperature -55±2°C,1000(+24)hours.	5
12	High Temperature Exposure (Storage)	①Precondition: 3 reflow cycles; ②Test condition: ambient temperature 150±2°C,1000(+24)hours.	(1) No visible mechanical damage(2) Inductance change: Within ±20%(3) DCR: Satisfy electrical characteristic.
13	Biased Humidity	Reflow 3 times, ambient temperature85°C,85%RH, 1000 hours.	
14	Operational Life	Reflow 3 times, ambient temperature 125±2°C, 1000(+24) hours, rated current.	
15	MSL	Team A: ①Pre- and Post- Stress Electrical and Visual Test; ②High temperature Bake:125+5/-0°C,24 h; ③Temperature&Humidity Soak:85°C,85%RH,168 h; ④Reflow:MAX.260°C/10 s, 3 times.	(1) No visible mechanical damage (2) Inductance change: Within ±20%
16	Flammability	Refer to MIL-STD-202 Method 111、UL-94	 t1 or t2:≤10s; t1 plus t2 for the 5 specimens:≤50s; t2+t3 for each specimen:≤30s; No after-flame or after-glow of any specimen up to the holding clamp; No cotton indicator ignited by flaming particles or drops.
17	ESD Test	HBM ESD discharge waveform, each 1 time of +/- polarity. Voltage refer to 4KV; Inductance ≥ 22uh; 8KV; Inductance < 22uh;	(1) No visible mechanical damage(2) Inductance change: Within ±20%(3) DCR: Satisfy electrical characteristic.
18	Electrical characteristics	ambient temperature 25°C(15+3min) →ambient temperature -55°C(15+3min) →ambient temperature +150°C(15+3min).	Inductance change should be within ±20% of reference value measuring at 25°C
19	solvent resistance test	Add Aqueous wash chemical. OKEM Clean or equivalent. Do not use banned solvents.	No specified markings which are missing in whole or in part, faded, smeared, blurred, or shifted (dislodged) to the extent; No specimen shall have cracks, separations, crazing, swelling, softening, and degradation of body material, end caps and seals if present.

9 Packaging and Storage

9.1 Tape and Reel Packaging Dimensions

9.1.1 Taping Dimensions (Unit: mm)

Please refer to Fig. 9.1.1 and Table 9.1.1.



[Table9.1.1] Unit: mm

Series	A ₀	B ₀	W	E	F	P ₀	P ₁
AMP0402H	4.4±0.1	4.9±0.1	12.0±0.3	1.75±0.1	5.5±0.1	4.0±0.1	8.0±0.1
Series	P ₂	D ₀	Т	К	D ₁	1	1
AMP0402H	2.0±0.10	1.5±0.10	0.35 ± 0.05	2.3±0.1	1.5±0.10		/

9.1.2 Direction of rolling

Please refer to Fig. 9.1.2

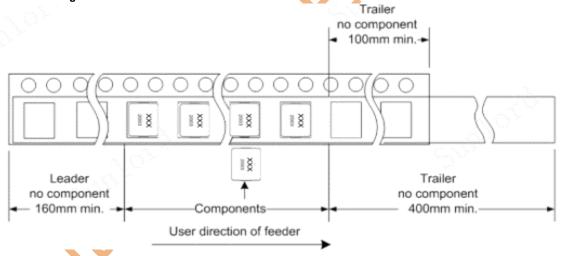


Fig. 9.1.2

9.1.3 Reel Dimensions (Unit: mm)

Please refer to Fig. 9.1.3.

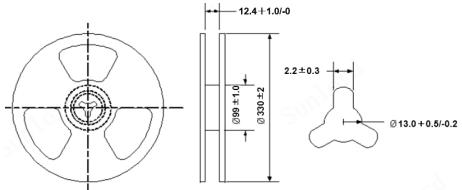


Fig.9.1.3

Carrier tape

Top tape or cover tape

9.1.4 Top tape strength

Peel-off strength: 10~130gf.

Peel-off angle: 165°~180°, refers to Fig. 9.1.4.

Peel-off speed: 300mm/min.

9.1.5 The number of components

A tape & reel package contains 3000 inductors.

9.1.6 The allowable number of empty chip cavities: 0 chip.

Fig.9.2.3-2a Fig.9.2.3-2b

[Table 9.2.3-1]

Packaging type

Inner box

Fig. 9.1.4

Fig.9.2.3-1

B(mm)

30

C(mm)

340

A(mm)

340

165⁰ to 180⁰

9.2 Packing Documents and Marking

9.2.1Packing Documents

Packing documents include the following:

- 1) Packaging list
- 2) Certificate of compliance (COC)

9.2.2Packing QTY.

- 1) Inner Box: 1 reel in each box.
- Outer Box:7 inner boxes in each outer case. 2)
- 7 reels in each outer case. 3)

9.2.3Marking

1)Marking label information on reels includes (see Fig.9.2.3-1~2):

Fig.9.2.3-2a: Shipping labels

- P/O No. a).
- Customer Part No. b).
- c). Sunlord Part No.
- d). Quantity.
- e). Lot No.
- f). Date code
- g). Inspection stamp
- MFG address as 'Made In China'.

Fig.9.2.3-2b: Production label

- a). P/N
- b). Quantity..
- c). Lot No.
- d). Inspe No
- Inspection stamp
- MFG address as 'Made In China'.
- sequence number g).

-	7

Fig.9.2.3-3

P/O No.: XXXX $\times \times \times \times \times$ Cust. P/N: Sunlord Shenzhen Sunlord Electronics Co., Ltd. Made in China

Fig.9.2.3-2a

P/N: XXXXXXXXXXXXX Qty: XXXXXXXX Lot No: XXXXXXXXXXXXXX Inspe No: XXXXXXXXXX XX XXX Sunlord Made in China

Fig.9.2.3-2b

[Table 9.2.3-2]

Packaging type	L(mm)	W(mm)	H(mm)
TYP1	335	335	200

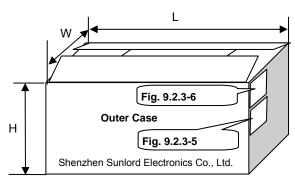


Fig. 9.2.3-4

- 2)Marking label information on inner box
 - a). Inner box please refers to Fig.9.2.3-3 and Table 9.2.3-1.
 - b). Marking Label on inner box

N/A

3)Marking on outer case (see Fig.9.2.3-4~6):

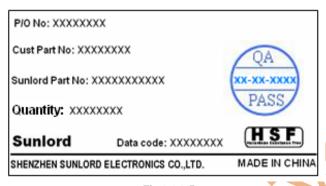
Out case size pleases reefers to Table 9.2.3-2.

- a). Manufacturer: Sunlord ID:
 - "Shenzhen Sunlord Electronics Co., Ltd."
- b). Packing label include the following:
 - i) Customer
 - ii) Manufacturer
 - iii) Date code
 - iv) C/No.

Example; "1/10" means that this case is the 1st

of total 10 cases

- v) P/O No.
- vi) Customer Part No.
- vii) Sunlord Part No.
- viii) Quantity.
- ix) Inspection Stamp.



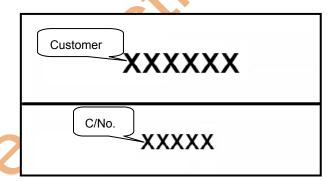


Fig.9.2.3-5

Automotive Molded SMD Power Inductor Business Categories: Level 0 (general confidential)

10 Visual inspection standard of product

File No: Effective date:		Applied to Automotive Molded SMD Power Inductor		REV:01
No.	Defect Item	Graphic	Rejection identification	Acceptance
1	Core defect	L tw	The defect length and width (L and W) more than 2mm, NG.	AQL=0.065
2	Core crack		Cracks can be seen on the bottom surface by eyes, NG.	AQL=0.065
3	Electrode surface dirt		dirt can be seen on the electrode surface by eyes, NG.	AQL=0.065
4	Marking defect	2R 200	The content of marking is indistinct or indistinguishable, NG;	AQL=0.065

11 Recommended Soldering Technologies

11.1Re-flowing Profile:

△ Preheat condition: 150 ~200 °C/60~180sec.

△ Allowed time above 217°C: 60~150sec.

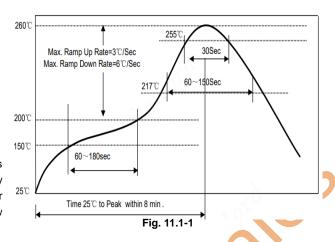
△ Allowed time above 255°C: 30sec. ref.

 \triangle Max temp: 260°C.

△ Max time at max temp: 5sec. Solder paste: Sn/3.0Ag/0.5Cu.

△ Allowed Reflow time: 3x max: Please refer to **Fig. 11.1-1**.

[Note: The reflow profile in the above table is only for qualification and is not meant to specify board assembly profiles. Actual board assembly profiles must be based on the customer's specific board design, solder paste and process, and should not exceed the parameters as the Reflow profile shows.]



11.2 Iron Soldering Profile

 \triangle Iron soldering power: Max. 30W.

△ Pre-heating: 150°C/60sec.

△ Soldering Tip temperature: 350°C Max.

△ Soldering time: 3sec. Max.

△ Solder paste: Sn/3.0Ag/0.5Cu.

 \triangle Max.1 times for iron soldering:

Please refer to Fig. 11.2-1.

[Note: Take care not to apply the tip of the soldering iron to the terminal electrodes.]

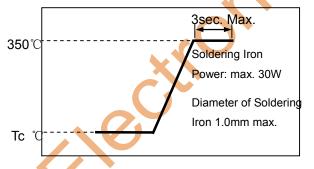


Fig. 11.2-1

12 Precautions

12.1 Surface mounting

- Mounting and soldering condition should be checked beforehand.
- Applicable soldering process to this product is reflow soldering only.
- Recommended conditions for repair by soldering iron:

Preheat the circuit board with product to repair at 150°C for about 1 minute.

Put soldering iron on the land-pattern.

Soldering iron's temperature: 350°C maximum/Duration: 3 seconds maximum/1 time for each terminal.

The soldering iron should not directly touch the inductor.

Product once removes from the circuit board may not be used again.

12.2 Handing

- Keep the products away from all magnets and magnetic objects.
- Be careful not to subject the products to excessive mechanical shocks.
- Please avoid applying impact to the products after mounted on pc board.
- Avoid ultrasonic cleaning.

12.3 Storage

- To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
- Recommended conditions: -10°C~40°C, 70%RH (Max.).
- Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used with one year from the time of delivery.
- In case of storage over 6 months, solderability shall be checked before actual usage.

12.4 Regarding Regulations

- Any Class- I or Class- II ozone-depleting substance (ODS) listed in the Clean Air Act in US for regulation is not included in the products or applied to the products at any stage of whose manufacturing processes.
- Certain brominated flame retardants (PBBs, PBDEs) are not used at all.
- The products of this specification are not subject to the Export Trade Control Order in China or the Export Administration Regulations in US.

12.5 Guarantee

- The guaranteed operating conditions of the products are in accordance with the conditions specified in this specification.
- Please note that Sunlord takes no responsibility for any failure and/or abnormality which is caused by use under other than the aforesaid operating conditions.
- 12.6 Please make sure to record the lot number on the label when using Sunlord's products in order for good traceability.